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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/622,307	07/18/2003	Randy Skocypec	ITL.1017US (P16704)	4356	
21906 TROP PRUNE	7590 01/11/2007 R & HU. PC		EXAMINER		
1616 S. VOSS ROAD, SUITE 750 HOUSTON, TX 77057-2631			CARRILLO, BIBI SHARIDAN		
			ART UNIT	PAPER NUMBER	
			1746		
SHORTENED STATUTOR	Y PERIOD OF RESPONSE	MAIL DATE	DELIVERY MODE		
3 MO	NTHS	01/11/2007	PAPER		

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

2) Notice 3) Infom	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTC nation Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date	D-948)	4) Interview Summary Paper No(s)/Mail D: 5) Notice of Informal F 6) Other:	ate	
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12) a)[Acknowledgment is made of a claim fo All b) Some * c) None of: 1. Certified copies of the priority do 2. Certified copies of the priority do 3. Copies of the certified copies of application from the International see the attached detailed Office action	ocuments have been becoments have been the priority documents Bureau (PCT Rul	en received. en received in Applicati ents have been receive e 17.2(a)).	ion No ed in this National Stag	e
9)	The specification is objected to by the The drawing(s) filed on is/are: a Applicant may not request that any objection. Replacement drawing sheet(s) including the oath or declaration is objected to be under 35 U.S.C. § 119	a) accepted or b) on to the drawing(s) the correction is required.	be held in abeyance. Se red if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.1	
5)□ 6)⊠ 7)□ 8)⊠	Claim(s) is/are allowed. Claim(s) <u>1,2,5,7 and 8</u> is/are rejected. Claim(s) is/are objected to. Claim(s) <u>1-2, 5, 7-19</u> are subject to reson Papers				
4)⊠	on of Claims Claim(s) <u>1,2,5 and 7-19</u> is/are pending 4a) Of the above claim(s) <u>9-17</u> is/are w	• • •			
3)	Since this application is in condition for closed in accordance with the practice				rits is
	Responsive to communication(s) filed This action is FINAL .	on <u>27 October 200</u>))∐ This action is r			
Status	· · · · · · · · · · · · · · · · · · ·				
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	Office Action Summary	10/622,3		SKOCYPEC ET AL.	
		Applicati	on No.	Applicant(s)	

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-2, 5, and 7 are rejected under 35 U.S.C. 102(b) as being anticipated by Brown et al. (US2002/0121289A1).

Brown et al. teach positioning a wafer between a pair of rotating brushes 13, 15 and spraying a solution at the interface between the brushes and wafer while the brushes are in contact with the wafer. Paragraph 25 teaches the spray bar directing fluid to a desired location (i.e. a substrate, scrubber brush, air/substrate interface, air/substrate/cleaning fluid interface, air/substrate/rinsing fluid interface). Paragraph 5 teaches directing the fluid by nozzles 21 to the brushes and/or substrate S. In reference to claim 1, the limitations of providing a cleaning solution through at least one of the brushes are inherently met as a result of the spray bar spraying the brush, as illustrated in Fig. 4. In reference to claim 1, the limitations are inherently met since the brushes appear to be porous because of the holes on the brushes, as illustrated by Fig. 4. In reference to the cleaning solution including a chemical and deionized water, refer to paragraph 26 of Brown. In reference to spraying only deionized water and claim 5, refer to paragraph 36 of Brown. In reference to claim 2, Fig. 4 shows the cleaning solution being sprayed at the center of the brushes. Additionally, paragraph 47 teaches that an

Art Unit: 1746

additional spray bar may be employed to deliver fluid to the brush 15. In reference to claim 5, refer to Fig. 4. In reference to claim 7, Brown teaches in paragraph 37 a second spray bar assembly for directing fluid towards a desired location.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:
 - 1. Determining the scope and contents of the prior art.
 - 2. Ascertaining the differences between the prior art and the claims at issue.
 - 3. Resolving the level of ordinary skill in the pertinent art.
 - 4. Considering objective evidence present in the application indicating obviousness or nonobviousness.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to

Art Unit: 1746

consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

5. Claim 8 is rejected under 35 U.S.C. 103(a) as being unpatentable over Brown et al. (US2002/0121289A1) in view of Mikhaylichenko et al. (6951042).

Brown teaches the invention substantially as claimed with the exception of the limitations of claim 8. Mikhaylichenko teaches cleaning a substrate by brush scrubbing in order to effectively clean the wafer after chemical mechanical polishing (col. 11, lines 44-65). Mikhaylichenko further teaches brush scrubbing both sides of the wafer by convention methods, which include applying fluid through the brush core as illustrated in Fig. 5a. Fig. 2e teaches applying a solution via nozzle 127 as the wafer is scrubbed by rotating brush 112. In col. 11, lines 45-65, Mikhaylichenko teaches using various fluid mediums to remove contaminants present on the wafer surface after chemical mechanical polishing.

It would have been obvious and within the level of the skilled artisan to modify the method of Brown to include cleaning after CMP, as taught by Mikhaylichenko, for purposes of removing contaminants from the substrate surface.

6. Claim 1-2, 5, and 7-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Brown et al. (US2002/0121289A1) in view of Mikhaylichenko et al. (6951042).

Brown et al. teach positioning a wafer between a pair of rotating brushes 13, 15 and spraying a solution at the interface between the brushes and wafer while the brushes are in contact with the wafer. Paragraph 25 teaches the spray bar directing fluid to a desired location (i.e. a substrate, scrubber brush, air/substrate interface,

Art Unit: 1746

air/substrate/cleaning fluid interface, air/substrate/rinsing fluid interface). Paragraph 5 teaches directing the fluid by nozzles 21 to the brushes and/or substrate S. In reference to claim 1, the limitations of providing a cleaning solution through at least one of the brushes are inherently met as a result of the spray bar spraying the brush, as illustrated in Fig. 4.

In the alternative that Brown et al. do not teach providing the cleaning solution through at least one of the brushes, the limitations are met by the secondary reference of Mikhaylichenko et al. Brown et al. teach PVA brushes. In Fig. 5a, Mikhaylichenko teaches the use of PVA brushes (i.e. sponge brushes) having a plurality of openings 212d for applying cleaning solution to the rotating wafers in order to dislodge and remove contaminants from the substrate surface (col. 11, lines 20-25, 40-45). It would have been obvious to a person of ordinary skill in the art to have modified the PVA brushes of Brown, to include PVA sponge brushes, as taught by Mikhaylichenko, for purposes of applying cleaning solution to the rotating wafer in order to further remove and dislodge contaminants from the wafer surface. In reference to the cleaning solution including a chemical and deionized water, refer to paragraph 26 of Brown. In reference to spraying only deionized water and claim 5, refer to paragraph 36 of Brown.

In reference to claim 2, Fig. 4 shows the cleaning solution being sprayed at the center of the brushes. Additionally, paragraph 47 teaches that an additional spray bar may be employed to deliver fluid to the brush 15. In reference to claim 5, refer to Fig. 4. In reference to claim 7, Brown teaches in paragraph 37 a second spray bar assembly for directing fluid towards a desired location.

Art Unit: 1746

Brown teaches the invention substantially as claimed with the exception of the limitations of claim 8. Mikhaylichenko teaches cleaning a substrate by brush scrubbing in order to effectively clean the wafer after chemical mechanical polishing (col. 11, lines 44-65). Mikhaylichenko further teaches brush scrubbing both sides of the wafer by convention methods, which include applying fluid through the brush core as illustrated in Fig. 5a. Fig. 2e teaches applying a solution via nozzle 127 as the wafer is scrubbed by rotating brush 112. In col. 11, lines 45-65, Mikhaylichenko teaches using various fluid mediums to remove contaminants present on the wafer surface after chemical mechanical polishing.

It would have been obvious and within the level of the skilled artisan to modify the method of Brown to include cleaning after CMP, as taught by Mikhaylichenko, for purposes of removing contaminants from the substrate surface.

Response to Arguments

7. Applicant argues that PVA brushes of Brown cannot provide cleaning solution through at least one of the brushes because a PVA brush is s nylon-like plastic material. Applicant's arguments are unpersuasive for the following reasons. In reference to claim 1, the limitations are inherently met since the brushes appear to be porous because of the holes on the brushes, as illustrated by Fig. 4. In the alternative that Brown et al. do not teach providing the cleaning solution through at least one of the brushes, the limitations are met by the secondary reference of Mikhaylichenko et al. Brown et al. teach PVA brushes. In Fig. 5a, Mikhaylichenko teaches the use of PVA brushes (i.e.

Art Unit: 1746

sponge brushes) having a plurality of openings 212d for applying cleaning solution to the rotating wafers in order to dislodge and remove contaminants from the substrate surface (col. 11, lines 20-25, 40-45). It would have been obvious to a person of ordinary skill in the art to have modified the PVA brushes of Brown, to include PVA sponge brushes, as taught by Mikhaylichenko, for purposes of applying cleaning solution to the rotating wafer in order to further remove and dislodge contaminants from the wafer surface. Additionally, there is no suggestion or teaching that the PVA brush of Brown et al. is a nylon like plastic material unable to flow cleaning solution throughout. Applicant further argues that the circles shown on the scrubbing rollers of Brown are nubs, not holes. The burden is shifted on applicant to show that the circular regions on the rollers are nubs not holes since there is not suggestion or teaching that the PVA brush of Brown et al. is a nylon like plastic material unable to flow cleaning solution throughout. In the semiconductor art, it is well known to use PVA sponge brushes of apply cleaning solution to the wafer surface to further remove contaminants, as evidenced by deLarios et al. (5810126). Therefore, since Brown et al. is cleaning wafers by scrubbing with PVA brushes, one would reasonably expect the PVA brushes to be made of a sponge material having openings for delivery of the cleaning solution.

Page 7

8. Applicant argues that Brown fails to teach using different solutions or spraying only deionized water. Applicant is directed to paragraphs 36 and 26 of Brown.

Additionally, Mikhaylichenko teaches in col. 11, lines 46-50 using water and aqueous chemical solutions.

Art Unit: 1746

9. This application contains claims 9-17 drawn to an invention nonelected with traverse in Paper filed 9/9/2004. A complete reply to the final rejection must include cancellation of nonelected claims or other appropriate action (37 CFR 1.144) See MPEP § 821.01.

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Sharidan Carrillo whose telephone number is 571-272-1297. The examiner can normally be reached on M-W 6:30-4:00pm, alternating Thursday.

Art Unit: 1746

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Barr can be reached on 571-272-1414. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Sharidan Carrillo Primary Examiner Art Unit 1746 Page 9

bsc

SHARIDAN CARRILLO PRIMARY EXAMINER